

# STP62NS04Z

# N-channel clamped 12.5 mΩ, 62 A, TO-220 fully protected MESH OVERLAY™ Power MOSFET

### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STP62NS04Z	Clamped	< 0.015 Ω	62 A

- 100% avalanche tested
- Low capacitance and gate charge
- 175 °C maximum junction temperature

### **Application**

Switching applications

### **Description**

Fully clamped MOSFET is produced by using ST's most advanced MESH OVERLAY™ process based on strip layout. The inherent benefits of this new technology coupled with the extra clamping capabilities make this product particularly suitable for the harshest operating conditions such as those encountered in the automotive environment. It is also recommended for any other application requiring extra ruggedness.

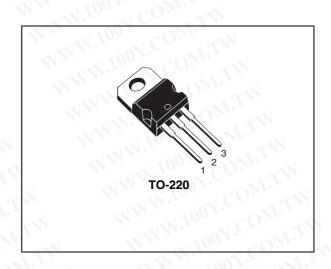


Figure 1. Internal schematic diagram

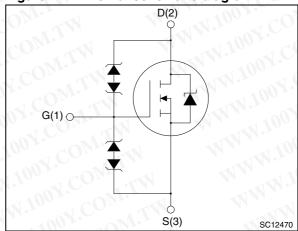


Table 1. Device summary

Order code	Marking	Package	Packaging
STP62NS04Z	P62NS04Z	TO-220	Tube

WWW.100Y.COM.TW HW.100Y.COM.TW ov.COM.TW WWW.100V.COM.TW COM.TW Contents STP62NS04Z MMM.100X.COM

# **Contents**

COM

1	Electrical ratings	741···
2	Electrical characteristics	LTW
	2.1 Electrical characteristics (curves)	
3	Test circuits	$O_{M_{1,1}}$
4	Package mechanical data	1.00N
5	Revision history	N.CO

WWW.100Y.COM.TW

MMM.100X.COW

WWW.100Y.COM.TW

WWW.1007.

MMM.100Y.COM.TW STP62NS04Z **Electrical ratings** 

# **Electrical ratings**

Table 2.	Absolute maximum ratings	COL	
Symbol	Parameter	Value	Ur
$V_{DS}$	Drain-source voltage (V <sub>GS</sub> = 0)	Clamped	V
V <sub>GS</sub>	Gate-source voltage	Clamped	٧
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	62	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> =100 °C	37.5	Α
I <sub>DG</sub>	Drain gate current (continuous)	± 50	m
I <sub>GS</sub>	Gate sourcecurrent (continuous)	± 50	m.
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	248	A
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	110	W
	Derating factor	0.74	W/ <sup>c</sup>
dv/dt (2)	Peak diode recovery voltage slope	800	V/r
E <sub>AS</sub> (3)	Single pulse avalanche energy	500	m
V <sub>ESD</sub>	ESD (HBM - C = 100 pF, R = 1.5 kΩ)	8	V
T <sub>J</sub>	Operating junction temperature Storage temperature	-55 to 175	

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-c</sub>	Thermal resistance junction-casemax	1.36	°C/W
R <sub>thj-a</sub>	Thermal resistance junction-ambient max	62.5	°C/W
T <sub>L</sub> .CC	Maximum lead temperature for soldering purpose	300	°C

WWW.100Y.CO

WWW.100Y.COM.TW

WWW.100Y.COM.TW

WWW.100X.COM

WWW.1007.

<sup>2.</sup>  $I_{SD} \leq$  40 A, di/dt  $\leq$  100 A/ $\mu$ s,  $V_{DD} \leq$   $V_{(BR)DSS}$ ,  $T_{j} \leq$   $T_{JMAX}$ 

Starting  $T_J = 25$  °C,  $I_D = 20$  A,  $V_{DD} = 20$  V

MMM.100Y.COM.TM W.100Y.COM.TW LCOM.TW **Electrical characteristics** STP62NS04Z 100X.COM

# W.100Y.COM.TW **Electrical characteristics** WW.100Y.COM.TW 2

On/off states Table 4.

Symbol	On/off states Parameter	Test conditions	Min.	Тур.	Max.	Uni
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0$	33	1,11	Muxi	V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 16 V	07.00	OM.	10	μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±10 V	1001	$CO_{M}$	10	μΑ
V <sub>GSS</sub>	Gate-source breakdown voltage	I <sub>GS</sub> = 100 μA	18	J.C	M.T	٧
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	01.	4	٧
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		12.5	15	mΩ

Symbol	Parameter	Test conditions	Min.	Тур.	Max.
9 <sub>fs</sub> (1)	Forward transconductance	$V_{DS} = 15 \text{ V}, I_{D} = 30 \text{ A}$	-	20	100
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	1330 420 135	M.T.
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 20 \text{ V}, I_{D} = 40 \text{ A}$ $V_{GS} = 10 \text{ V}$	LN -	34 10 11.5	47

MMM.10 1. Pulsed: pulse duration=300µs, duty cycle 1.5%

WWW.100 Table 6. Switching times

able 6.	Switching times					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{ m d(on)} \ t_{ m r} \ t_{ m d(off)} \ t_{ m f}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 20 V, $I_{D}$ = 20 A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ = 10 V Figure 14 on page 8	CO <sub>M</sub>	13 104 41 42	-	ns ns ns ns
t <sub>r(Voff)</sub> t <sub>f</sub> t <sub>C</sub>	Off-voltage rise time Fall time Cross-over time	$V_{clamp} = 30 \text{ V}, I_D = 40 \text{ A}$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ Figure 14 on page 8	107.CC	30 54 90	N	ns ns ns

WWW.100Y.COM.TW

Source drain diode

COM.TW

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current	TW TOW TOWN		1	62	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)	11001.00	M.	N	248	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 62 A, V <sub>GS</sub> = 0	27		1.5	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 40 A, di/dt = 100 A/ $\mu$ s, $V_{DD}$ = 20 V, $T_{J}$ = 150 °C Figure 16 on page 8		45 65 2.9	N	ns nC A

WWW.100Y.COM.TW

W.100Y.COM.TW

ICOM.TW

WWW.100Y.COM.TW

WWW.1007.

MMM.100Y.COM.TW

WWW.TOOX.COM.TW

MMM.100X.COM

Pulse width limited by safe operating area

Pulsed: pulse duration=300µs, duty cycle 1.5% WWW.100Y.CO! WWW.100Y.COM.TW

Electrical characteristics STP62NS04Z

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

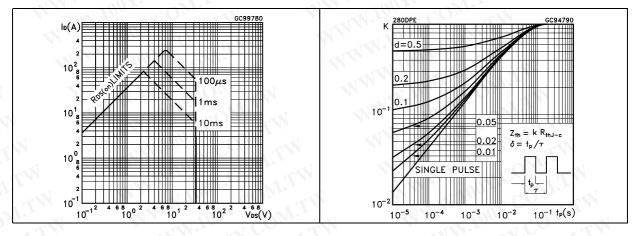


Figure 4. Output characterisics

Figure 5. Transfer characteristics

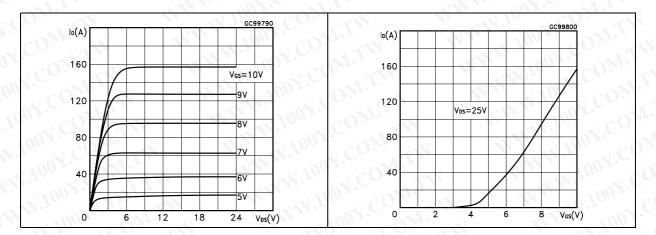
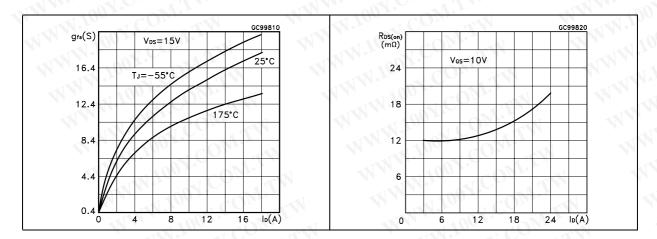


Figure 6. Transconductance

Figure 7. Static drain-source on resistance



M.M.N. 100 A. COM

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

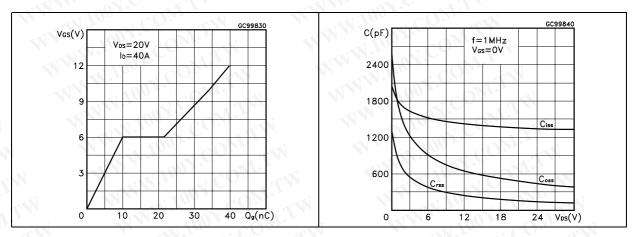


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

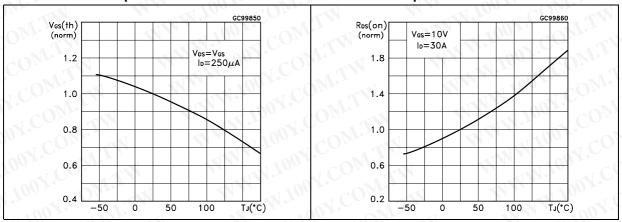
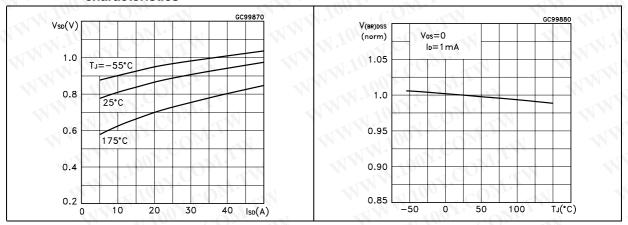


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized  $B_{VDSS}$  vs temperature



MMM.100X.COM

Test circuits STP62NS04Z

### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

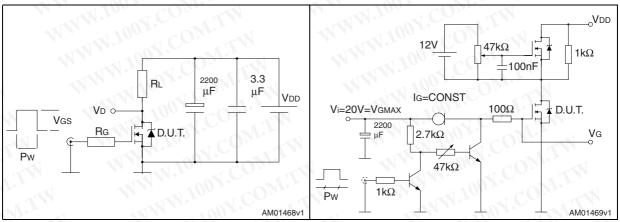


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

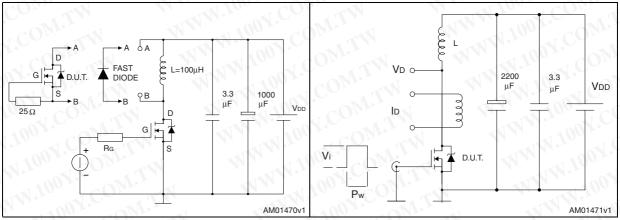
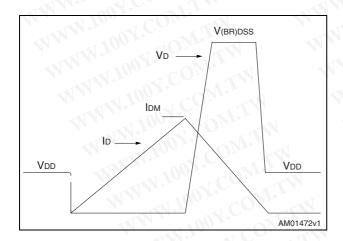


Figure 18. Unclamped inductive waveform



5

M.M.M. TOOK COM

#### Package mechanical data 4

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark. WWW.100Y.COM.T

MMM TOOK COM TW

N.100Y.COM.TW

CON.TW

WWW.100Y.COM.TW

WWW.100

M.M.M. TOOX COM TW

WWW.100X.

\*100X'COM'LA

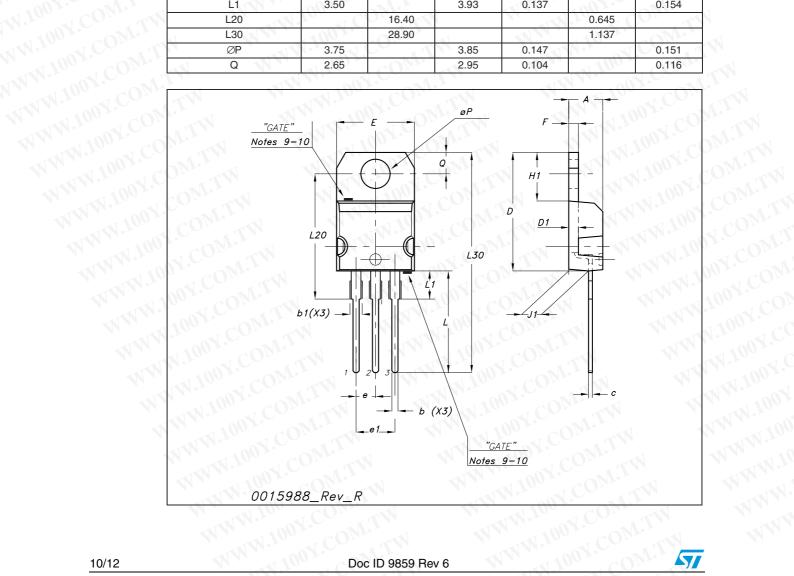
WWW.100Y.COM

WWW.IC

#### TO-220 mechanical data

MMM 100X COM TW

.007.		mm			inch	
Dim	Min	Тур	Max	Min	Тур	Max
A (O)	4.40		4.60	0.173		0.181
b	0.61	- 1	0.88	0.024	1.	0.034
b1 C	1.14		1.70	0.044		0.066
C	0.48	1	0.70	0.019	101.	0.027
D	15.25		15.75	0.6		0.62
D1	Ohr.	1.27	M.	100	0.050	N
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094	COE	0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048	4 CO	0.051
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
1/L 3/1/	13	N. T.	14	0.511	200	0.551
L1	3.50	-71.T	3.93	0.137	.007.	0.154
L20	×1 (	16.40			0.645	$O_{r}$
L30	1007.	28.90	<b>. . .</b> 1		1.137	
ØP	3.75		3.85	0.147	N. T	0.151
Q	2.65		2.95	0.104	1100	0.116



WWW.1007.

WWW.100Y.COM.TW

WWW.100Y.COM.TW NW.100Y.COM.TW ECON.TW COM.TW STP62NS04Z **Revision history** MMM:100X:COM MMM. 100

# **Revision history** WWW.

Table 8.

Date	Revision	Changes
21-Jun-2004	2	Preliminary datasheet
22-Aug-2005	3	Complete document with curves
21-Jan-2006	4	New ECOPAK label
02-Oct-2006	CO 5	New template, no content change
14-May-2009	6	Updated scheme in Figure 1

WWW.100Y.COM.TW

WWW.100X.

WWW.100Y.COM.TW

MMM.100X.COM

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2009 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

12/12 Doc ID 9859 Rev 6

